

# AIOT-MSSP01

Mini SSP Vending Control Board

User's Manual 2<sup>nd</sup> Ed

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### Packing List

Mini SSP Vending Control Bc

Before setting up your product, please make sure the following items have been shipped:

ltem		Quantity
•	AIOT-MSSP01	1
•	User's Manual (in pdf)	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

#### About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the AAEON.com for the latest version of this document.

#### Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- 2. Make sure the power source matches the power rating of the device.
- Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- Always completely disconnect the power before working on the system's hardware.
- 5. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 7. Always disconnect this device from any AC supply before cleaning.
- 8. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 9. Make sure the device is installed near a power outlet and is easily accessible.
- 10. Keep this device away from humidity.
- 11. Place the device on a solid surface during installation to prevent falls
- 12. Do not cover the openings on the device to ensure optimal heat dissipation.
- 13. Watch out for high temperatures when the system is running.
- 14. Do not touch the heat sink or heat spreader when the system is running
- 15. Never pour any liquid into the openings. This could cause fire or electric shock.
- As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.

- 17. If any of the following situations arises, please the contact our service personnel:
  - i. Damaged power cord or plug
  - ii. Liquid intrusion to the device
  - iii. Exposure to moisture
  - iv. Device is not working as expected or in a manner as described in this manual
  - v. The device is dropped or damaged
  - vi. Any obvious signs of damage displayed on the device

# DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

#### FCC Statement



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

#### Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

### China RoHS Requirements (CN)

产品中有毒有害物质或元素名称及含量

AAEON Main Board/ Daughter Board/ Backplane

	有毒有害物质或元素					
部件名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	(PBDE)
印刷电路板						
及其电子组件	0	0	0	0	0	0
外部信号						0
连接器及线材		0	0	0	0	0
O: 表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。						
X:表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。						
备注:此产品所标示之环保使用期限,系指在一般正常使用状况下。						

### China RoHS Requirement (EN)

Poisonous or Hazardous Substances or Elements in Products

AAEON Main Board/ Daughter Board/ Backplane

	Poisonous or Hazardous Substances or Elements					
Component	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
PCB & Other Components	0	0	0	0	0	0
Wires & Connectors for External Connections	0	0	0	0	0	0

O: The quantity of poisonous or hazardous substances or elements found in each of the component's parts is below the SJ/T 11363-2006-stipulated requirement.

X: The quantity of poisonous or hazardous substances or elements found in at least one of the component's parts is beyond the SJ/T 11363-2006-stipulated requirement.

Note: The Environment Friendly Use Period as labeled on this product is applicable under normal usage only

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# Chapter 1

Product Specifications

# 1.1 Specifications

External Connector

•	USB	USB 2.0 type A connector x 5 (via USB HUB)
		Micro USB 2.0 type B connector x 1 (USB HUB
		Host)
Inte	rnal Connector	
•	MDB	MDB x 1
•	1-Wire	1-WIRE x 1
•	DEX	DEX x 1
•	Protocol A	Protocol A (EXE) x 1
•	Keypad	8 Bit Keypad x 1
•	LCD	LCD x 1
•	ADC	4-channel ADC x 1
•	Relay GPIO	4-channel Relay GPIO for 12V & 5V by switch x 1
•	GPIO	16 Bit GPIO x 2
•	24V GPI	8 Bit 24V GPI x 1
•	24V Analog voltage sense	24V Analog voltage sense x 1
•	Power input	24VAC/DC Power Input
•	Motor Switch	Select motor 24Vdc or 12Vdc switch (Motor
		supports GPIO, DC, PWM type) x 1
•	Full bridge motor	Full bridge motor control x 5
•	Low side motor	Low side motor control x 16
•	Expansion header	2* 20 PIN header x 2

#### Others

- Form Factor
- Power Source
- Operating Temperature
- Operating Humidity
- Certification
- 150 mm x 140 mm
  - 24V AC @ 50Hz, 24vDC 0°C ~ 60°C
    - 0% ~ 90% relative humidity, non-condensing
    - CE, FCC

# Chapter 2

Hardware Information

AIOT-MSSP01

#### 2.1 Dimensions







#### 2.2 Jumpers and Connectors

#### 2.2.1 Main board layout



#### 2.2.1 I/O board layout



# 2.3 List of Connectors

Please refer to the table below for all of the board's connectors that you can configure for your application

#### 2.3.1 Mainboard Connector Index

Reference	Function	Connector Type
CN1	MCU-ICSP	(TF)PIN HEADER.5*1P:180D.(M).2.54mm.DIP
CN2	Vending detect	(TF)WAFER BOX.6P.180D(M).DIP.2.0mm.w/LOCK
CN4 CN6	IO BOARD	(TF)PIN HEADER.20*2P.180D(M).DIP.2.54mm
	CONNECTORS	
CN8	RS232	(TF)D-SUB CONNECTOR.9P.90D
CN9	Internal USB2.0	(TF)WAFER BOX.5P.180D(M).DIP.1.25mm
CN10	+5V output	(TF)WAFER.2P.180D(M).3.96mm.W/LOCK
CN12 CN13	External	(TF)USB2.0 Connector.4P.90D(F).DIP
CN14 CN15	USB2.0	
CN16		

# 2.3.1.1 MCU-ICSP (CN1)



Pin	Signal Description	Pin	Signal Description
1	MCLR#	2	+3.3V
3	GND	4	PGED1
5	PGED1		

# 2.3.1.2 Vending Detect (CN2)



Pin	Signal Description	Pin	Signal Description
1	VEND_DET_IN	2	GND
3	VEND_DET_ALARM	4	NC
5	GND	6	VEND_DETECT_VCC



Vending Detection /Vending Detection Power			
1-2	MVC600	Default	
2-3	CST539		

### 2.3.1.3 RS-232 (CN8)



Pin	Signal Description	Pin	Signal Description
1	N/A	2	RS232_RXD
3	RS232_TXD	4	N/A
5	GND	6	N/A
7	N/A	8	N/A
9	N/A		

# 2.3.1.4 USB2.0 (CN9)



Pin	Signal Description	Pin	Signal Description
1	5V	2	D-
3	D+	4	GND
5	GND		

# 2.3.1.5 5V supply (CN10)



Pin	Signal Description	Pin	Signal Description
1	5V	2	GBD

## 2.3.2 I/O board Connector Index

Reference	Function	Connector Type
CN1	Relay GPIO	(TF)WAFER BOX.8P.180D(M).DIP.2.5mm.W/LOCK
CN2	MDB	(TF)WAFER BOX.8P.180D(M).DIP.2.5mm.W/LOCK
CN3	+12V output	(TF)WAFER.2P.180D(M).3.96mm.W/LOCK
CN4	POWER	(TF) WAFER.6*1P.90D.(M).3.96mm.w/ Lock
	INPUT	
CN5	RS232	(TF)D-SUB CONNECTOR.9P.90D
CN6	UART	(TF)WAFER.4P.180D.(M).2.5mm.W/LOCK POWER DIP
CN7	+24V output	(TF)WAFER.2P.180D(M).3.96mm.W/LOCK
CN8	ADC	(TF)Wafer Box.6P.180D.(M).SMD.1.0mm.w/ CAP
CN9	24V ANALOG	(TF)WAFER BOX.2P.180D.(M).2.5mm.W/LOCK DIP
	INPUT	
CN10 CN16	16 Bit GPIO	(TF)WAFER BOX.10*2P.180D.(M).DIP.2.0mm.W/LOCK
CN11	24V	(TF)WAFER BOX.8*2P.180D.(M).DIP.2.0mm.W/LOCK
	VENDING	
	INPUT	
CN12	PROTOCOL A	(TF)WAFER BOX.6P.180D(M).DIP.2.0mm.w/LOCK
CN13	DEX	(TF)WAFER.4P.180D.(M).2.5mm.W/LOCK POWER DIP
	INTERFACE	
CN14	Keypad	(TF)WAFER BOX.10P.180D(M).SMD.1.25mm
 CN15	1-WIRE	(TF)WAFER.4P.180D.(M).2.5mm.W/LOCK POWER DIP

INTERFACE

CN18	LCD	(TF)Board-Wire
		Connector.20P.180D(M).SMD.Pitch=1.25mm.W/Reinforc
		em
CN19	FULL MOTOR	(TF)ATX POWER CONNECTOR.12P*2.180D(M)
CN20	HALF MOTOR	(TF)ATX POWER CONNECTOR.10P*2.180D.DIP

## 2.3.2.1 Relay GPO (CN1)



Pin	Signal Description	Pin	Signal Description
1	DO_0	2	DO_1
3	DO_2	4	DO_3
5	RELAY_PWR	6	RELAY_PWR
7	RELAY_PWR	8	RELAY_PWR



RELAY POWER MODE SELECTION			
1-2	+5V	Default	
2-3	+12		

### 2.3.2.2 MDB Master (CN2)



Pin	Signal Description	Pin	Signal Description
1	MDB_SUPPLY	2	EXT_24V_RTN
3	NC	4	MDB_RX
5	MDB_TX	6	GND
7	GND	8	GND

# 2.3.2.3 +12V Supply (CN3)

D	
	igodol

Pin	Signal Description	Pin	Signal Description
1	12V	2	GND

# 2.3.2.4 Power Input (CN4)



Pin	Signal Description	Pin	Signal Description
1	MDB_SUPPLY	2	EXT_24V_RTN
3	NA	4	MDB_RX
5	MDB_TX	6	GND

# 2.3.2.5 RS232 (CN5)



Pin	Signal Description	Pin	Signal Description
1	N/A	2	RS232_RXD
3	RS232_TXD	4	N/A
5	GND	6	N/A
7	N/A	8	N/A
9	N/A		

## 2.3.2.6 UART (CN6)



Pin	Signal Description	Pin	Signal Description
1	+3.3V	2	UART_TXD
3	UART_RXD	4	GND

-MSSP01

# 2.3.2.7 +24V Output (CN7)

Pin	Signal Description	Pin	Signal Description
1	MOTOR_PWR	2	GND

D





MOTOR POWER MODE				
SELECTION				
1-2	PWM	Default		
2-3	DC			

MOTOR POWER SELECTION				
1-2	12V	Default		
2-3	24V			

### 2.3.2.8 ADC (CN8)

Pin	Signal Description	Pin	Signal Description
1	ANALOG_IN1	2	ANALOG_IN2
3	GND	4	GND
5	ANALOG_IN3	6	ANALOG_IN4

 $\nabla$ 

# 2.3.2.9 16 Bit GPIO (CN10)



Pin	Signal Description	Pin	Signal Description
1	5V_CON_GPI1	2	5V_ CON _GPIO1
3	5V_CON_GPI2	4	5V_CON_GPIO2
5	5V_ CON _GPI3	6	5V_ CON _GPIO3
7	5V_CON_GPI4	8	5V_CON_GPIO4

9
1
1
1
1
1

9	5V_ CON _GPI5	10	5V_CON_GPIO5
11	5V_ CON _GPI6	12	5V_CON_GPIO6
13	5V_CON_GPI7	14	5V_CON_GPI07
15	5V_ CON _GPI8	16	5V_ CON _GPIO8
17	GND	18	GND
19	GND	20	GND

# 2.3.2.10 24V Vending Input (CN11)

	16							2	
5	•	•	•		•	•	•	•	2
Γ	•	•	•	ŏ	•	•	•		

Pin	Signal Description	Pin	Signal Description
1	24V_GPI1	2	24VIO_RTN_OPTO
3	24V_GPI2	4	24VIO_RTN_OPTO
5	24V_GPI3	6	24VIO_RTN_OPTO
7	24V_GPI4	8	24VIO_RTN_OPTO
9	24V_GPI5	10	24VIO_RTN
11	24V_GPI6	12	24VIO_RTN
13	24V_GPI7	14	24VIO_RTN

15	24V_GP18	16	24VIO_RTN

# 2.3.2.11 Protocol A (CN12)



Pin	Signal Description	Pin	Signal Description
1	MDBSLAVE_EXE_TX+_5V	2	MDBSLAVE_EXE_TX5V
3	MDBSLAVE_EXE_RX+_5V	4	MDBSLAVE_EXE_RX5V
5	PWR_IN_AC	6	GND

#### 2.3.2.12 DEX INTERFACE (CN13)



Pin	Signal Description	Pin	Signal Description
1	DEX_DET	2	GND
3	DEX_DOUT	4	DEX_RIN

## 2.3.2.13 Keypad (CN14)



Pin	Signal Description	Pin	Signal Description
1	5V	2	KEYPAD_0
3	KEYPAD_1	4	KEYPAD_2
5	KEYPAD_3	6	KEYPAD_4
7	KEYPAD_5	8	KEYPAD_6
9	KEYPAD_7	10	GND

#### 2.3.2.14 One Wire (CN15)



Pin	Signal Description	Pin	Signal Description
1	+3.3V	2	1-Wire DEVICE

3	GND	4	GND

# 2.3.2.15 16 Bit GPIO (CN16)



Pin	Signal Description	Pin	Signal Description
1	5V_HDR_GPI1	2	5V_HDR_GPIO1
3	5V_HDR_GPI2	4	5V_HDR_GPIO2
5	5V_HDR_GPI3	6	5V_HDR_GPIO3
7	5V_HDR_GPI4	8	5V_HDR_GPIO4
9	5V_HDR_GPI5	10	5V_HDR_GPIO5
11	5V_HDR_GPI6	12	5V_HDR_GPIO6
13	5V_HDR_GPI7	14	5V_HDR_GPIO7
15	5V_HDR_GPI8	16	5V_HDR_GPIO8
17	GND	18	GND
19	GND	20	GND

# 2.3.2.16 LCD (CN18)



Pin	Signal Description	Pin	Signal Description
1	GND	2	5V
3	5V(Variable Resistor)	4	DISPLAY_RS
5	DISPLAY_R/W	6	DISPLAY_EN
7	LCD_CN_0	8	LCD_CN_1
9	LCD_CN_2	10	LCD_CN_3
11	LCD_CN_4	12	LCD_CN_5
13	LCD_CN_6	14	LCD_CN_7
15	NA	16	GND
17	NA	18	NA
19	NA	20	NA

# 2.3.2.16 Full bridge motor (CN19)



Pin	Signal Description	Pin	Signal Description
1	MOTOR_RTN	2	FULL_BRIDGE_1_BR
3	FULL_BRIDGE_1_TR	4	FULL_BRIDGE_2_BR
5	FULL_BRIDGE_2_TR	6	FULL_BRIDGE_3_BR
7	MOTOR_RTN	8	FULL_BRIDGE_3_TR
9	FULL_BRIDGE_4_BR	10	FULL_BRIDGE_4_TR
11	FULL_BRIDGE_5_BR	12	FULL_BRIDGE_5_TR
13	MOTOR_VOLTAGE	14	FULL_BRIDGE_1_TL
15	FULL_BRIDGE_1_BL	16	FULL_BRIDGE_2_TL
17	FULL_BRIDGE_2_BL	18	FULL_BRIDGE_3_TL
19	MOTOR_VOLTAGE	20	FULL_BRIDGE_3_BL
21	FULL_BRIDGE_4_TL	22	FULL_BRIDGE_4_BL
23	FULL_BRIDGE_5_TL	24	FULL_BRIDGE_5_BL

# 2.3.2.17 Low side motor (CN20)



Pin	Signal Description	Pin	Signal Description
1	LOWSIDE1_M1	2	LOWSIDE1_M2
3	LOWSIDE1_M3	4	LOWSIDE1_M4
5	LOWSIDE1_M5	6	LOWSIDE1_M6
7	LOWSIDE1_M7	8	LOWSIDE1_M8
9	MOTOR_RTN	10	MOTOR_RTN
11	LOWSIDE2_M1	12	LOWSIDE2_M2
13	LOWSIDE2_M3	14	LOWSIDE2_M4
15	LOWSIDE2_M5	16	LOWSIDE2_M6
17	LOWSIDE2_M7	18	LOWSIDE2_M8
19	MOTOR_RTN	20	MOTOR_RTN
21	MOTOR_RTN		







HOME P	HOME POSITION MODE		
SELECTIC	N		
1-2	DC		

1-2	DC	
2-3	PWM	Default

MOTOR RETURN GND		
SELECTION	1	
1-2	DC	
2-3	PWM	Default

# Chapter 3

Motor Setup

AIOT - MSSPO

#### 3.1 Introduction

The AIOT-MSSP01 supports four types of motor configurations. Please refer to the following motor configuration setting information.

#### 3.2 Full Bridge Motor Configuration



# 3.3 Low Side Motor Configuration



#### 3.4 High Side Motor Configuration



# 3.4 Half Motor Configuration

+ M



CTRL1	CTRL2	Motor Status
0	0	Break
1	0	Rotate

# Chapter 4

Installation Guide

AIOT - MSSPO

#### 4.1 Firmware Installation

Please follow the steps below to install/update firmware.

#### 4.1.1 Prerequisites

- Install software MPLAB IPE. To download, use the following link: http://microchip.wikidot.com/ipe:installation
- 2. Install toolchain MPLABX-v3.45-windows-installer

#### 4.1.2 Program Boot-loader

Step 1: Connect ICD 3 to the target board and apply power to the board.





Step 2: Connect ICD3 device with the board and then plug in power

Chapter 4 – Installation Guide

#### Step 3: Launch MPLAB IPE application



MPLAB IPE v3.45

Family: Please chose 32-bit MCUs (PIC32)

Device: Please select PIC32MX795F512L

Tool: Please select ICD 3 (with appropriate serial number)

	and Tool		Results	
Family: Device:	All Families PIC32MX795F512L	<ul> <li>Apply</li> </ul>	Check Pass Cr	sum: F7D83853
fool:	ICD 3 S.No : JT112940924	▼ Connect	Total C	ount: [3]
Ŧ	rogram 💆 Erase	Read	Verify	Blank Check
Source: Plea	se click on browse button to import a hex file	8		Browse
SQTP: Plea	se click on browse button to import SQTP fil	ß		Browse
				# Fe22
tput	4.54.0000 C 1.11 Y TTT			
6-12-19 10-3	4:54 +0800 - Completed loading IPE.			

Microchip IPE initial screen

**Step 5:** After selecting the connect button to connect to the target board, the following screen will appear.

	and Tool			Results		
Family:	All Families		•	Chec	ksum: F7D83853	
Device:	evice: PIC32MX795F512L ool: ICD 3 & No : ITT112940924		- Apply	Pass Count 20 Feil Count 3		
Tool:			• Disconnect	Total	Total Count 23	
<u>.</u>	Program	Ence	Read	Verify	Blank Check	
Source: Plea	ae click on browse b	utton to import a hex file	J	1	Browse	
SQTP: Plea	se click on browse b	utton to import SQTP file			Browse	
					# Less	
					* Less	
ntput					* Less	
nput 16-12-19 11 (	12-52 +0800 - Comp	leted loading IPE.			a Less	
nput 16-12-19 11 f	12-52 +0800 - Comp	lend looding IPE.	•••		a Less	
tiput 16-12-19 11 ( matching to M mently loaded movers Suite T movare Spin-	12-52 +0800 - Comp IPLAB ICD 3 farmware on ICD 3 ferrion12.8.72 	forbed loading IPE.	***		a Less	
nput 16-12-19 11 ( nuescing to M means Suite 1 means Suite 1	12:52 +0800 - Comp 12:48 ICD 3 1. firmware on ICD 3 Persion01 28:72 * PIC32MX PIC32MX Pictud C32MX795F512L & ion = 54300053	leted loading IPE.	***		# Less	

**Microchip IPE screen after connection** 

**Step 6**: Please click on "Browse" and locate the firmware hex file from source side in order to load Hex file. You will then see an acknowledge message in MPLAB IPE as shown below.

	ја нејр					
Select Device	e and Tool			Results		
Family:	All Families -			Chec	Checksum: FA4C07EC	
Device: PIC32MX795F512L -		• •	Apply	Pess Count: 20 Feil Count: 3		
Tool	ICD 3 S.No : ЛТ112940924 •		Disconnect		Total Count 23	
<b>1</b>	Program		Read	🖳 Verify	В	lank Check
Source: C.V	IL Userskywachow/Desktop/PIC32MX795F512L	_20160706_crb,	.00.1wx		JL	Browse
SQTP: Plea	ase click on browse button to import SQTP file	£.				Browse
						± Less
utpot						
utpot	fPLAB ICD 3 8 fizmware on ICD 3					
utpot samecting to b mently loader mease Suite ' mease type	(PLABICD 3 firmwere on ICD 3 Version01 28.72 * 					
utput utput numering to b numering loader movare Suite 1 movare Suite 1 movare Suite 1 numering loader numering loade	IPLAB ICD 3           firmware on ICD 3           Yersion0128.72 *					

Microchip IPE Hex file loaded screen

**Step 7**: Please click on the Program button. After successfully programming, you will see the screen shown below.

View Setting	ıs Help						
Select Devic	e and Tool				Results		
Family:	All Families	2			a	weckram: FA4C0	7BC
Device:	PIC32MX795F512	L	•	Apply	Pa Fo	es Count: 21 al Count: 3	
Tool	ICD 3 S No : RT11	2940924	-] [	Disconnect	Tot	al Count: 24	
<b></b>	Pogram			r			
		Etane	1 1	Read	Yenty	Bla	ak Check
Source: C.V	Userskystachovi Desktopi (* 10	32MX795F512L_2	0160706_crb_6	Read	Yenity	Bla	ak Check Browne
Source: C.V. SQTP: Fin	UserskopenchoviDesktop/PIC see click on browse button ti	32MX795F512L_2	0160706_crb_6	i00 hex	Yendy Yendy	Bix	Boowse Boowse
Sours: C.V. SQIP: Pie	UserskynachoviDesktop/PIC aar elick on browse button i	320MX795F512L_2	1160706_crb_6	Read 00 hex	<b>V</b> eafy	Ba	Browne Browne ± Less
Source: C.V. SQTP: File Output	UserskynachoviDeaktopiPiC ase elack on browse button fi	32MX795F512L_2	1160706_crb_6	Read 000 hex	Yendy Yendy	Bix	Browse Browse * Less
Source: C.X SQTP: Pie Output 2016-12-19 11: 2016-12-19 11: Device Erased	UterritymachouiDesktop/PIG see clicik on browse button t 04-52 +0800 - Hex file load 06:03 +0800 - Programming	Ense     Industry     Spin 21     Dimport SQTP file	1160706_crb_6	Read 000 hex	Yendy Yendy		Browne Browne * Less
Source: CX SQTP: File Output 2016-12-19 11: 2016-12-19 11: Device Erased Programming	UterritymachoviDesktop/PIC see click on browse button t 04-52 +0800 - Hex file load 06-03 +0800 - Programming	Ense	0160706_crb_6	Read 000 hex	Yendy		Ak Check Browne Browne * Less
Source: C.V. SQTP: File Output 2016-12-19 11: 2016-12-19 11: 2016-12-19 11: Device Erased Programming The following in program memory boot config memory boot config memory boot config memory	UserstrysmichoviDesktop/PIC see click on browse button is 04-52 +0800 - Hex file load 06-03 +0800 - Programming semory assa(a) will be progra y: start address = 0x0, end e nory enfory complete enfory	Ense     S2MX795F512L_2     import SQTP file  ed successfully.  E-  nonmed: ddress = 0x54fff	0160706_crb_6	Read 000 hex	Yendy		Browse Browse * Less

**Microchip IPE Programming complete** 

OT-MSSP01

#### The HEX file has been successfully loaded to MCU PIC32.

Select Device	and Tool		Results		
Family:	All Families -		Chec	cksum: FA4C07EC	
Device:	vice: PIC32MX795F512L -		Pass Fail	Pass Count: 20 Fail Count: 3	
lcol: ICD 3 S.No : ЛТ112940924 - Discon			Total Count: 23		
P:	rogram	Read	Venify	Blank Check	
Source: C:\U	perskymnchou/Desktop/FIC32MX795F512L_20160	706_crb_600.hex		Browse	
SQTP: Pleas	e click on browse button to import SQTP file			Browse	
				▲ Less	
utput					
**************************************	PLAB ICD 3			-	
innware Suite Ve innware type	ersion01.28.72 * 			=	
arget voltage det arget device PIC evice ID Revisio 016-12-19 11:04 016-12-19 11:04	tected 32MX795F512L found. m = 54300053 4:52 +0800 - Loading hex file. Please wait 1:52 +0800 - Hex file loaded successfully.				

#### Microchip IPE Hex file loaded screen

#### 4.2 Vending SDK Installation

#### 4.2.1 Windows 10 Version

Please follow the steps below to install supporting software programs before installing Intel\_Intelligent\_Vending\_Sample\_Application.exe.

Step 1 Install QT 5.8 https://download.qt.io/official\_releases/qt/5.8/5.8.0/ qt-opensource-windows-x86-msvc2015-5.8.0.exe

**Step 2** Update the PATH environment variable to include needed QT and Axis2C runtime binaries.

**Step 3** In order to update the environment variable PATH in Windows 10, please follow the steps below.

Step 3.1 Right click the Windows start button in the lower left hand corner.

Step 3.2 Click System from the menu.

Step 3.3 Click Advanced System Settings from the left panel.

Step 3.4 Click the Environment Variables button in the popup.

Step 3.5 In the System Variables section scroll to PATH and click the button.

**Step 3.8** In the popup add the above paths and click the New button for each line: c:\Qt\Qt5.8.0\5.8\msvc2015\bin

c:\Qt\Qt5.8.0\5.8\msvc2015\plugins\sqldrivers c:\Qt\Qt5.8.0\5.8\msvc2015\plugins\mediaservice c:\Qt\Qt5.8.0\5.8\msvc2015\plugins\platforms C:\Users\<TODO\_ADD\_WINDOWS\_USER\_NAME\_HERE>\AppData\Local\Intel\_Corpora tion\Intel(R) Intelligent Vending Sample Application\API\Bin\Windows\axis2c\lib

**Remark**: If there is no button to add each line and only a single textbox exists then add all paths separated by ;

For example:

<ANY\_EXISTING\_PATHS\_HERE>;c:\Qt\Qt5.8.0\5.8\msvc2015\bin;c:\Qt\Qt5.8.0\5.8\msv c2015\plugins\sqldrivers;c:\Qt\Qt5.8.0\5.8\msvc2015\plugins\mediaservice;c:\Qt\Qt5.8. 0\5.8\msvc2015\plugins\platforms;C:\Users\<TODO\_ADD\_WINDOWS\_USER\_NAME\_H ERE>\AppData\Local\Intel\_Corporation\Intel(R) Intelligent Vending Sample Application\API\Bin\Windows\axis2c\lib

Step 4 Please Install Telemetry DependenciesStep 4.1 Install Mosquitto or another MQTT broker of your choice.

#### Remark

Mosquitto download is located here: https://mosquitto.org/download/ mosquitto-1.4.12-install-win32.exe Mosquitto will need OpenSSL and pthreadVC2 DLLs copied to its install directory. You will first need to install Mosquitto, and then copy the files to the Mosquitto Windows install directory (C:\Program Files (x86)\mosquitto\), install MSVC100 (see below). Then re-install Mosquitto.

Step 4.2 Download pthreadvc2.dll

Use the prebuilt package at <u>ftp://sourceware.org/pub/pthreads-win32</u> and download the file pthreads-w32-2-9-1-release.zip.

**Step 4.3** After extracting the folder, copy Pre-built2/dll/x86/pthreadVC2.dll to your Mosquitto install directory.

**Step 5** For OpenSSI, you can copy libeay32.dll and ssleay32 dlls from the Vending SDK install directory C:\Users\<TODO\_ADD\_WINDOWS\_USER\_NAME\_HERE>\AppData\Local\Intel\_Corpora tion\Intel(R) Intelligent Vending Sample Application\API\Bin\Windows

Step 6 Please download MSVC100 the installer be downloaded from Microsoft using Microsoft Visual C++ 2010 Redistributable Package (x86) at https://www.microsoft.com/en-us/download/details.aspx?id=5555

You will be able to successfully install and run the vending API program after installing support software.

#### 4.2.2 Ubuntu 16.04 Xenial

Step 1 Copy the Ubuntu\_16.04\_Xenial\_Release folder to your Ubuntu machine.
Step 2 Open a terminal and execute: sudo su
Step 3 In the terminal change directories to your copy of the Ubuntu\_16.04\_Xenial\_Release folder
Step 4 In the terminal execute: chmod +x install.sh
Step 5 In the terminal execute: ./install.sh
Step 6 When prompted "Do you want to continue" enter Y to install all the software

components.

Please make sure you have a working Internet connection and follow the steps below.

Step 7 When prompted enter the password for MariaDb: root123

Step 8 After the install has completed successfully, in the terminal, execute: mysql -u root -p

Step 9 When prompted enter root123 as the password.

Step 10 Execute: source intel\_vending.sql

**Step 11** After the above sql file has been installed execute exit to exit. In the terminal execute: cd /usr/local/bin. Utilize any of the Start\*.sh files to start the test apps, VendingDemo, Telemetry.

In the terminal execute: cd /usr/local/bin. Utilize any of the Start\*.sh files to start the test apps, file name: VendingDemo

#### 4.2.3 Update vending SDK for Ubuntu 16.04 Xenial

If you already have the SDK installed on Ubuntu 16.04 Xenial, please follow the steps below to upgrade an existing system.

Step 1 Copy the Ubuntu\_16.04\_Xenial\_Release folder to your Ubuntu machine.

Step 2 Open a terminal and execute: sudo su

Step 3 In the terminal change directories to your copy of the Ubuntu\_16.04\_Xenial\_Release folder

Step 4 In the terminal execute: dpkg -r IntelVendingSDK

Step 5 In the terminal execute: dpkg -i IntelVendingSDK-3.5.8.0-Linux.deb

## 4.2.4 Update DB in vending SDK for Ubuntu 16.04 Xenial

If the upgrade requires a DB update, please follow the steps below.

Step 1 In the terminal execute: mysql -u root -p

Step 2 When prompted enter root123 as the password.

Step 3 Execute: source intel\_vending.sql

Step 4 After the above sql file has been installed execute exit to exit.

**Note:** Re-installing the \*.deb or install.sh will NOT erase any changes previously made to the Vending database. Only Vending Demo files in the UI folder will be erased.